4.4-5.0 GHz 4W



Description

The HWA1441 is a high-efficiency, wide instantaneous bandwidth, fully input/output matched power amplifier (PA) with high gain and linearity.

The compact 16-pin 5 \times 5 mm PA is designed for TDD system, support 5G NR FR1 band n79 Wireless Infrastructure operating from 4400 to 5000MHz.

The active biasing circuitry is integrated to compensate PA performance over temperature, voltage, and process variation.

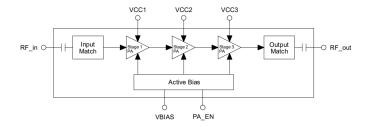
This amplifier is part of Hexawave's high-efficiency 4W PA RF product line designed for wireless infrastructure supporting major 3GPP bands.



Features

- Wide instantaneous signal bandwidth :
 100 MHz
- **High Efficiency**: PAE = 31.0% @ Pout = 28 dBm
- **High Linearity**: ACLR < -50 dBc @ Pout = 28 dBm with DPD (5G NR, 8.5 dB PAR CCDF 0.01% signal)
- **High output power** : Psat > 35 dBm
- High power gain : 35.5 dB
- Single supply voltage ∶ Vcc = 5.0 V
- Integrated enable On/Off function : PAEN = 2.0 ∨
- Integrated active bias : performance compensated over temp
- 50 Ω matched input and output
- Compact (16-pin, $5 \times 5 \times 1.07$ mm) package (MSL3, 260 °C per JEDEC J-STD-020)

Functional Block Diagram



Applications

- Supports 5G TDD systems
- Supports 3GPP 5G NR FR1 bands n79
- Small cells for wireless communications infrastructure and massive MIMO
- Repeaters / DAS
- General purpose wireless



Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units
RF Input Power (CW)	Pin		+10	dBm
Supply Voltage (VCC1, 2, 3 and VBIAS)	Vcc		5.5	V
PA Enable	VEN		3.6	V
Operating Temperature	Тор	-40	+110	$^{\circ}$
Storage Temperature	Тѕтс	-55	+125	$^{\circ}$
Junction Temperature (for 10 ⁶ hours MTTF)	TJ		+175	$^{\circ}$
Power Dissipation	Po		1.83	W
Device Thermal Resistance	θις		15	°C/W
Electrostatic Discharge :	ESD			
Charged Device Model (CDM) Human Body Model (HBM)			500 1000	V V

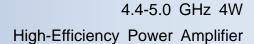
Note: If the satisfied of any one or more of the above conditions will lead to equipment damage.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

Recommended Operating Ranges

Parameter	Symbol	Min	Тур	Max	Unit
Operation Frequency	Freq.	4.4		5.0	GHz
Supply Voltage (VCC1, 2, 3 and VBIAS)	Vcc	4.75	5.0	5.5	V
PA Enable ON OFF	Ven	1.7	2.0 0	3.6 0.5	V
PA Enable Current*	IEN		5	10	uA
Operation Temperature	Tc	-40	+25	+110	$^{\circ}$

*Note: This current is when PA Enable is 2V, if the voltage increases, the current will also increase accordingly.





■Electrical Specifications

VCC1, 2, 3 = VBIAS = 5.0V, PA_EN = 2.0V , Tc = 25 $^{\circ}\text{C}$, Input/Output Impedance 50 $\!\Omega$, unless otherwise noted

• Small Signal Characteristics

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.		4400	4700	5000	MHz
Small Signal Gain	S21	$P_{IN} = -30dBm$	32.6	35.0		dB
Input Return Loss	S11	$P_{IN} = -30dBm$		13.5	24.3	dB
Output Return Loss	S22	$P_{IN} = -30dBm$		11.7	30	dB
Reverse Isolation	S12	P _{IN} = -30dBm		50.8		dB
Quiescent Current	Icq	No RF Signal		109		mA

• Large Signal Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.			4400		MHz
Gain @+28dBm	S21	Pout = +28dBm		36.1		dB
ACLR @+28dBm	ACLR PAR Sign			-31.5		dBc
Output Power for 1 dB Compression	OP1dB	CW, Reference to Gain @ Pout = 20dBm		29.1		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		33.3		dBm
2 nd Harmonic	2f ₀	CW, Pout = +28dBm		-30.5		dBc
3 rd Harmonic	3fo	CW, Pout = +28dBm		-41.3		dBc
Power Added Efficiency	PAE	CW, Pout = +28dBm		17.1		%
Total Operating Current Itotal		pins 5, 12, 14 and 16 Pout = +28dBm		751		mA
RF turn-on / turn-off time				200		ns



4.4-5.0 GHz 4W High-Efficiency Power Amplifier

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.			4500		MHz
Gain @+28dBm	S21	Роит = + 2 8dBm		35.9		dB
ACLR @+28dBm	ACLR	ACLR POUT = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-32.0		dBc
Output Power for 1 dB Compression	OP1dB	CW, Reference to Gain (Pout = 20dBm)		31.8		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		35.2		dBm
2 nd Harmonic	2 f ₀	CW, Роит = + 28dBm		-35.7		dBc
3 rd Harmonic	3 fo	CW, Роит = + 28dBm		-44.5		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dBm		22.2		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Роит = +28dBm		562		mA
RF turn-on / turn-off time				200		ns

Parameter	Symbol	Test Conditions		Тур	Max	Unit
Frequency	Freq.			4600		MHz
Gain @+28dBm	S21	Роит = + 2 8dBm		35.5		dB
ACLR @+28dBm	ACLR	POUT = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-32.5		dBc
Output Power for 1 dB Compression	OP1dB	OP1dB CW, Reference to Gain (Pout = 20dBm)		33.2		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		36.1		dBm
2 nd Harmonic	2f ₀	CW, Роит = + 28dBm		-41.1		dBc
3 rd Harmonic	3f o	CW, Роит = + 28dBm		-46.6		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dBm		28.0		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Pout = +28dBm		457		mA
RF turn-on / turn-off time				200		ns



4.4-5.0 GHz 4W High-Efficiency Power Amplifier

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.			4700		MHz
Gain @+28dBm	S21	Роит = +28dBm		35.5		dB
ACLR @+28dBm	ACLR	Pout = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-33.4		dBc
Output Power for 1 dB Compression	OP1dB	CW, Reference to Gain (Pout = 20dBm)		33.6		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		36.1		dBm
2 nd Harmonic	2 f ₀	CW, Роит = + 28dBm		-46.7		dBc
3 rd Harmonic	3 fo	CW, Роит = + 28dВ m		-49.8		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dBm		31.0		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Роит = +28dBm		417		mA
RF turn-on / turn-off time				200		ns

Parameter	Symbol	ol Test Conditions		Тур	Max	Unit
Frequency	Freq.			4800		MHz
Gain @+28dBm	S21	Ро ит = +28dBm		35.9		dB
ACLR @+28dBm	ACLR	ACLR POUT = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-33.5		dBc
Output Power for 1 dB Compression	OP1dB	OP1dB CW, Reference to Gain (Pout = 20dBm)		33.6		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		35.9		dBm
2 nd Harmonic	2f ₀	CW, Роит = + 28dВm		-50.6		dBc
3 rd Harmonic	3 fo	CW, Роит = + 28dВm		-51.1		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dВm		29.7		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Роит = +28dBm		437		mA
RF turn-on / turn-off time				200		ns



4.4-5.0 GHz 4W High-Efficiency Power Amplifier

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.			4900		MHz
Gain @+28dBm	S21	Роит = +28dBm		35.8		dB
ACLR @+28dBm	ACLR	POUT = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-31.2		dBc
Output Power for 1 dB Compression	OP1dB	CW, Reference to Gain (Pout = 20dBm)		33.5		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		35.5		dBm
2 nd Harmonic	2 f ₀	CW, Роит = + 28dBm		-54.1		dBc
3 rd Harmonic	3 fo	CW, Роит = + 28dBm		-53.6		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dBm		25.6		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Роит = +28dBm		500		mA
RF turn-on / turn-off time				200		ns

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Frequency	Freq.			5000		MHz
Gain @+28dBm	S21	Роит = + 2 8dBm		34.7		dB
ACLR @+28dBm	ACLR	ACLR POUT = +28dBm (100MHz 5G NR, 8.5dB PAR Signal)		-29.3		dBc
Output Power for 1 dB Compression	OP1dB	CW, Reference to Gain (Pout = 20dBm)		33.2		dBm
Saturated Output Power	Psat	Use duty cycle100% CW tone		34.9		dBm
2 nd Harmonic	2f ₀	CW, Роит = + 28dBm		-52.9		dBc
3 rd Harmonic	3f ₀	CW, Роит = + 28dBm		-53.5		dBc
Power Added Efficiency	PAE	CW, Роит = + 28dBm		22.0		%
Total Operating Current	I _{total}	Pin 5, 12, 14 and 16 Роит = +28dBm		574		mA
RF turn-on / turn-off time				200		ns

HWA1441



4.4-5.0 GHz 4W

High-Efficiency Power Amplifier

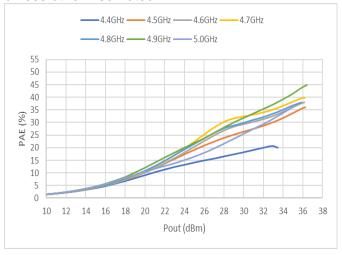
Notes:

- 1. Performance is guaranteed only under the conditions listed in this table.
- 2. RF turn-on time is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power achieves 90% of the average steady-state "on" level.
- 3. RF turn-off time is measured from the time the PA enable reaches 50% of PA enable "on" level to the time at which the RF output power decreases to 10% of the average steady-state "on" level.



■Typical Performance Characteristics

VCC1, 2, 3 = VBIAS = 5.0V, PA_EN = 2.0V, Freq. = 4900MHz, TC = 25° C, Input/Output Impedance = 50Ω , unless otherwise noted



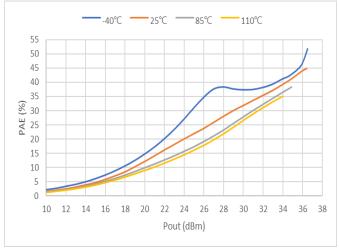
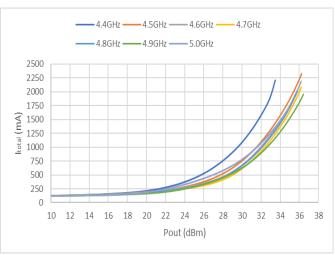


Figure 1. PAE vs Pout (CW) Across Frequency

Figure 2. PAE vs Pout (CW) Across Temperature



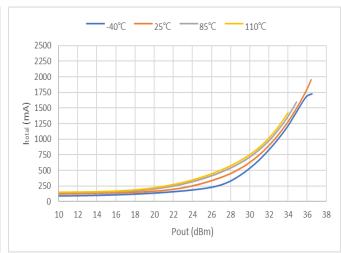


Figure 3. Itotal vs Pout Across Frequency

Figure 4. Itotal vs Pout Across Temperature



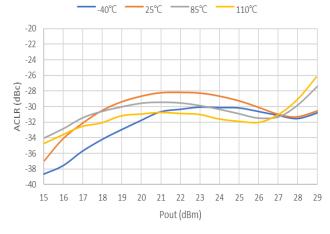
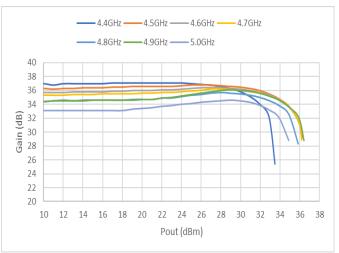


Figure 5. ACLR (1x100 MHz) vs Pout Across Frequency

Figure 6. ACLR (1x100 MHz) vs Pout Across Temperature





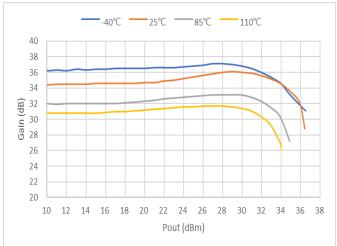


Figure 7. Gain vs Pout Across Frequency

Figure 8. Gain vs Pout Across Temperature

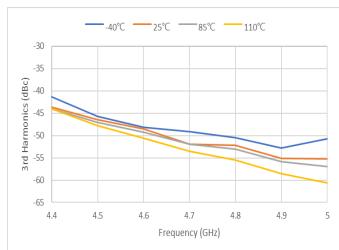


Figure 9. 2nd Harmonic @ +28 dBm (CW) vs Frequency Across Temperature

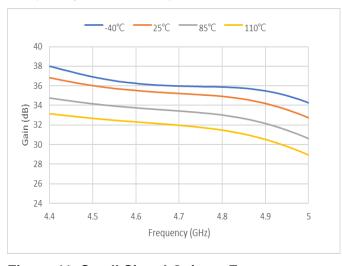


Figure 10. 3rd Harmonic @ +28 dBm (CW) vs Frequency Across Temperature

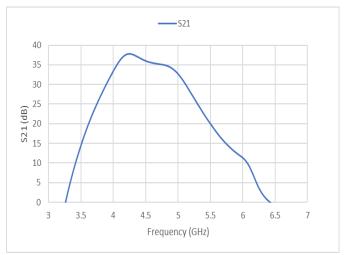


Figure 11. Small Signal Gain vs Frequency Across Temperature

Figure 12. Wide-Band S21 vs Frequency



4.4-5.0 GHz 4W

High-Efficiency Power Amplifier

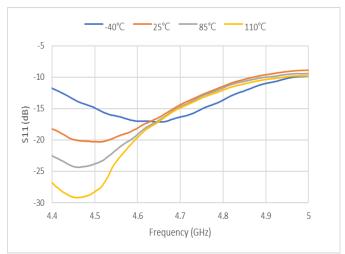


Figure 13. S11 vs Frequency Across Temperature (Pin = -30 dBm)

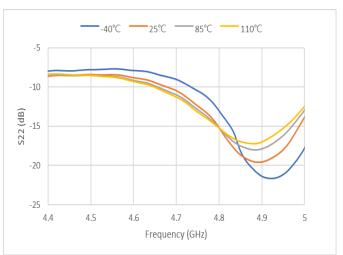
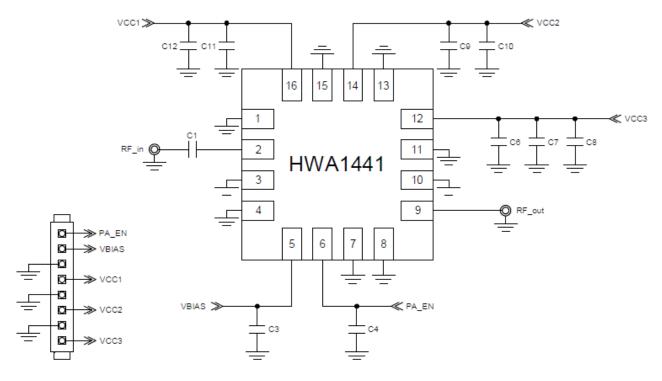


Figure 14. S22 vs Frequency Across Temperature (Pin = -30 dBm)



Application Circuit



Pin Assignments

Pin No.	Name	Description	Pin No.	Name	Description
1	GND	Ground	9	RF_out	RF Output Port
2	RF_in	RF Input Port	10	GND	Ground
3	GND	Ground	11	GND	Ground
4	GND	Ground	12	VCC3	Stage 3 Collector Voltage
5	VBIAS	Bias Voltage	13	GND	Ground
6	PA_EN	PA Enable	14	VCC2	Stage 2 Collector Voltage
7	GND	Ground	15	GND	Ground
8	GND	Ground	16	VCC1	Stage 1 Collector Voltage

Note:

The matching circuits are contained within the device. The HWA1441 is internally matched for maximum output power and efficiency. The input and output stages are independently supplied using the VCC1, VCC2, and VCC3 supply lines (pins 16, 14, and 12, respectively). The DC control voltage that sets the bias is supplied by the VCBIAS signal (pin 5).



Evaluation Board Bill of Material (BOM)

Component	Value / Part Number	Description
IC	HWA1441	4.4G to 5.0GHz, High-Efficiency Power Amplifier
C1	0R	Resistor, 0402
C3	1uF	Ceramic Capacitor, 0402
C4, C7	3300pF	Ceramic Capacitor, 0402
C6	1uF	Ceramic Capacitor, 0402
C8, C10, C12	10uF	Ceramic Capacitor, 1206
C 9	0.47uF	Ceramic Capacitor, 0402
C11	0.1uF	Ceramic Capacitor, 0402

Note: The center ground pad must have a low inductance and low thermal resistance connection to the application's printed circuit board ground plane.

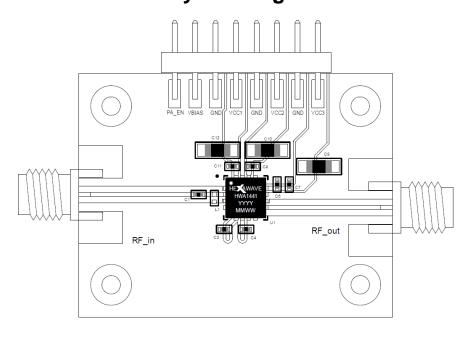
Evaluation Board Test Procedure

- ♦ Turn-On Sequence
 - 1. Connect 50 Ohm Test Equipment or Load to the input and output RF ports of the Evaluation Board.
 - 2. Connect the DC ground.
 - Connect all VCCs and VBIAS lines to a +5.0 V supply. Connect PA_EN to a 2.0 V supply.
 - 4. Without applying RF, turn on the 5.0 V supply, then turn on the 2.0 V PA_EN.
 - 5. Apply RF signal data at -30 dBm and observe that the gain of the device is correct. Begin measurements.
- ♦ Turn-Off Sequence
 - 1. Turn off the RF input to the device.
 - 2. Turn off PA_EN (set to 0 V).
 - 3. Turn off all VCCs and VBIAS.

Note: It is important to adjust the VCC voltage sources so that +5.0 V is measured at the board. High collector currents drop the collector voltage significantly if long leads are used. Adjust the bias voltage to compensate.



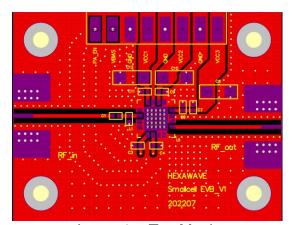
Evaluation Board Assembly Drawing



Notes:

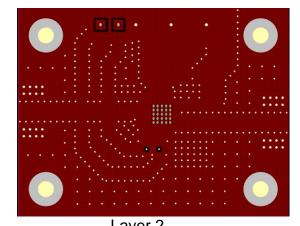
- 1. The C1 component shown in this assembly is a 0Ω resistor.
- 2. The L1 component shown in this assembly is DNI.

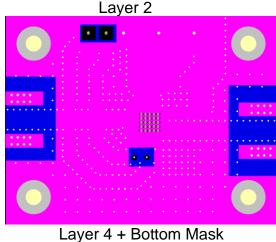
■Board Layer Detail



Layer 1 + Top Mask

Layer 3







Layer Detail Physical Characteristics

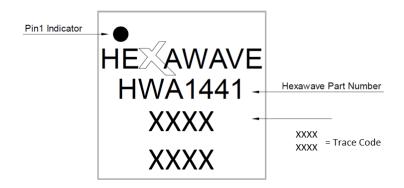
50 🖺 hm	Crass Section	Name Th	nickness(mm)	Materials
W=0.500mm		TMask	0.010	Solder Resist
		L1	0.035	Cu, 1oz.
		Dielectric	0.250	R04350
		L2	0.035	Cu, 1oz.
		Dielectric	0.350	FR4
		L3	0.035	Cu, 1oz.
		Dielectric	0.250	FR4
		L4	0.035	Cu, 1oz.
		BMask	0.010	Solder Resist

Application Circuit Notes

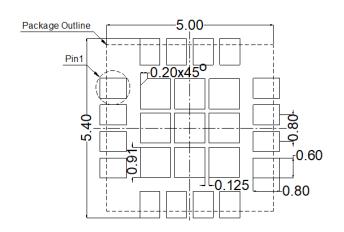
- Center Ground. It is extremely important to sufficiently ground the bottom ground pad of the device for both thermal and stability reasons. Multiple small vias are acceptable and work well under the device if solder migration is an issue.
- 2. **GND (pins 1, 3, 4, 7, 8, 10, 11, 13, and 15).** Attach all ground pins to the RF ground plane with the largest diameter and lowest inductance via that the layout allows. Multiple small vias are acceptable and will work well under the device if solder migration is an issue.
- 3. VCBIAS (pin 5). The bias supply voltage for each stage, nominally set to +5 V.
- 4. **RFOUT (pin 9).** Amplifier RF output pin (ZO = 50 Ohm). The module includes an internal DC blocking capacitor. All impedance matching is provided internal to the module.
- 5. VCC1, VCC2, and VCC3 (pin 16, 15, and 12, respectively). Supply voltage for each stage collector bias is nominally set to 5 V. The evaluation board has inductors L1 and L2. These are place holders, and should be populated with 0 Ohm resistors. Bypass and decoupling capacitors C6 through C12 should be placed in the approximate location shown on the evaluation board assembly drawing, although exact placement is not critical.
- 6. **RFIN (pin 2).** Amplifier RF input pin (ZO = 50 ohm). All impedance matching is provided internal to the module.

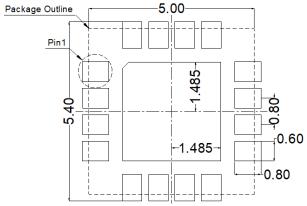


Typical Part Marking



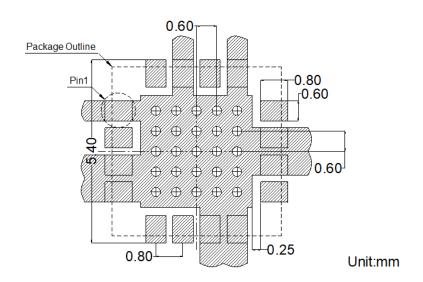
■PCB Layout Footprint Patterns





Stencil Aperture Top View

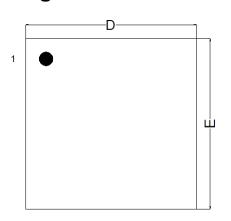
Solder Mask Opening Top View

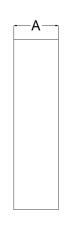


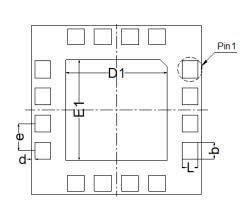
Metallization Top View



■Package Dimensions







Top View

Side View

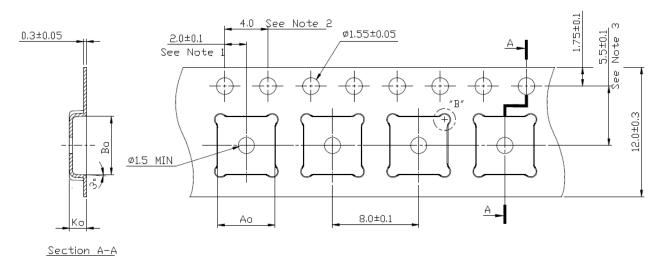
Bottom View

Symbol	Min	Max	Unit
Α	1.00	1.14	
b	0.45	0.55	
D	4.90	5.10	
D1	2.92	3.02	
d	0.00	0.20	mm
E	4.90	5.10	
E1	2.92	3.02	
е	0.80		
L	0.42	0.52	

4.4-5.0 GHz 4W



■HWA1441 Tape and Reel Dimensions

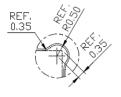


Ao=5.3±0.1mm Bo=5.3±0.1mm Ko=1.3±0.1mm

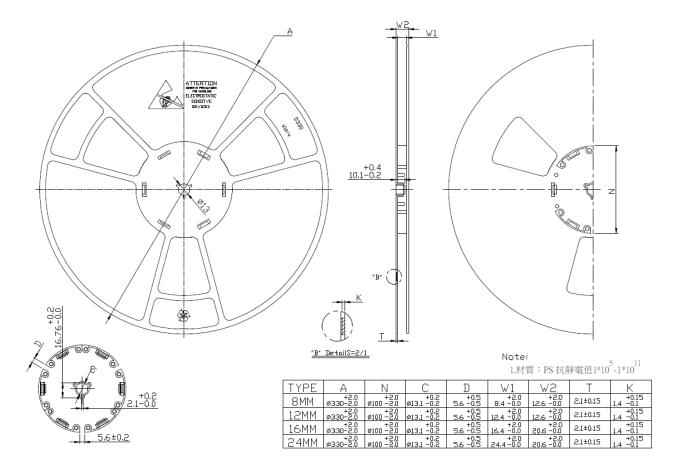
Notes:

1.Measured from centreline of sprocket hole to centreline of pocket. 2.Cumulative tolerance of 10 sprocket holes is ± 0.20 .

3.Measured from centreline of sprocket hole to centreline of pocket. 4.D ther material available.



<u>"B" Detai</u> S=2/1





4.4-5.0 GHz 4W High-Efficiency Power Amplifier

■Ordering Information

Part Number	Product Description	Evaluation Board Part Number
HWA1441	4400 to 5000 MHz Wide Instantaneous High-Efficiency PA	HWA1441-EVB